



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

## Product Specification

▶ Domestic Part Number	BSC050N04LSG
▶ Overseas Part Number	BSC050N04LSG
▶ Equivalent Part Number	BSC050N04LSG



EV is the abbreviation of name EVVO

## -20V P-Channel Enhancement Mode MOSFET

### Description

The BSC050N04LSG is the high cell density trenched P-ch MOSFETs, which provides excellent RDSON and efficiency for most of the small power switching and load switch applications.

The BSC050N04LSG meet the RoHS and Green Product requirement with full function reliability approved.

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

### Product Summary

$V_{DS} = -20V$   $I_D = -2A$

$R_{DS(ON)} = 70\text{ m}\Omega$  @  $V_{GS}=4.5\text{ V}$

$R_{DS(ON)} = 110\text{ m}\Omega$  @  $V_{GS}=2.5\text{ V}$

### SOT23 Pin Configuration



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D@T_A=25^\circ\text{C}$	Continuous Drain Current, $V_{GS}$ @ -4.5V <sup>1</sup>	-2	A
$I_D@T_A=70^\circ\text{C}$	Continuous Drain Current, $V_{GS}$ @ -4.5V <sup>1</sup>	-2.4	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	-12	A
$P_D@T_A=25^\circ\text{C}$	Total Power Dissipation <sup>3</sup>	0.5	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Data

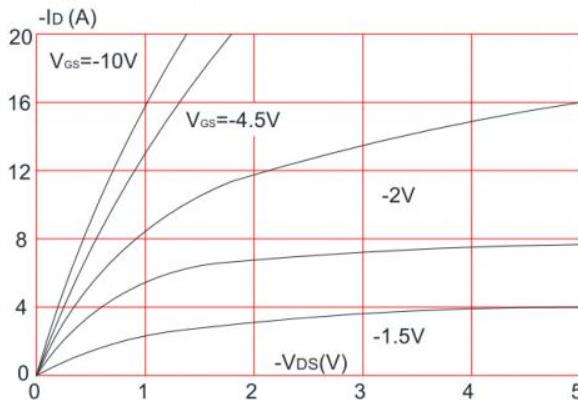
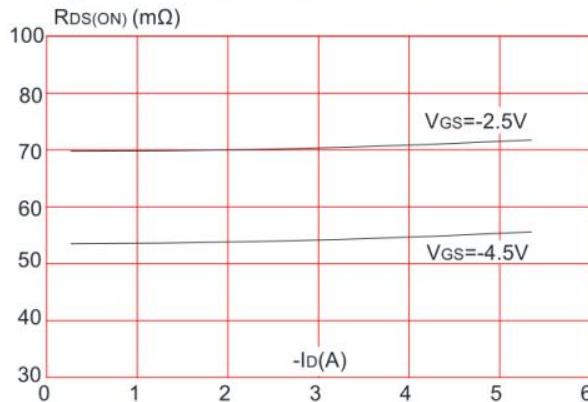
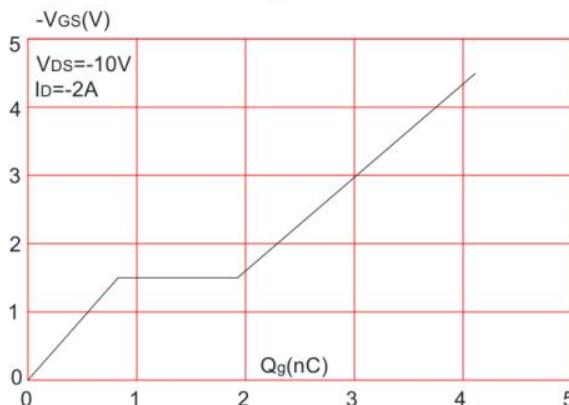
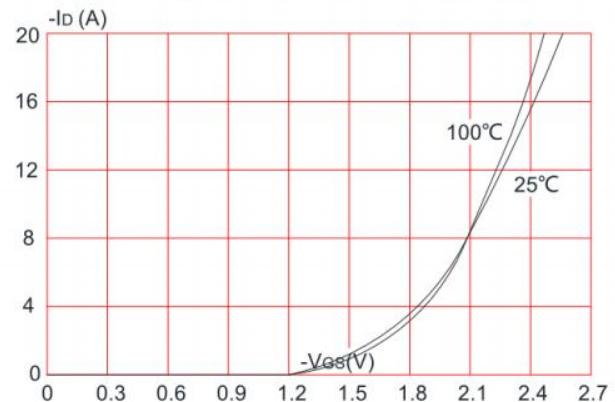
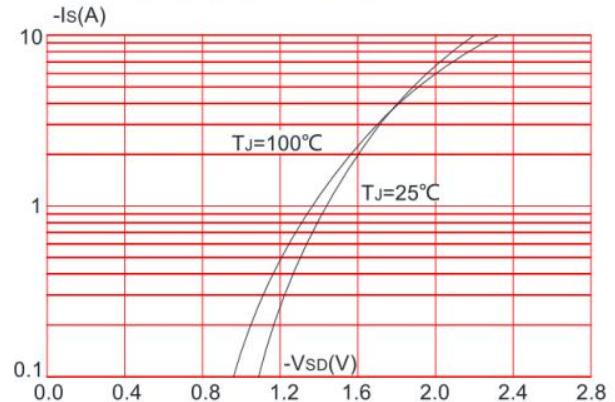
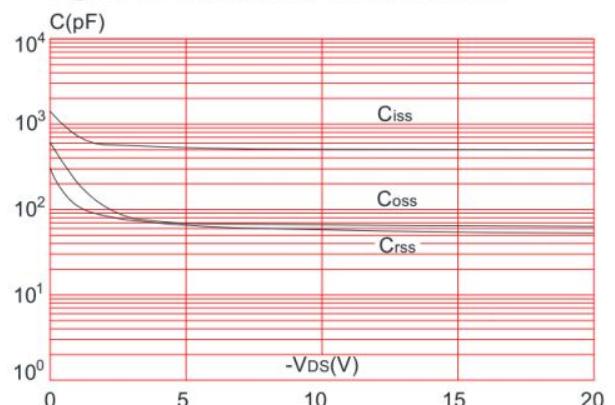
Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient <sup>1</sup>	---	250	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>1</sup>	---	75	°C/W

**-20V P-Channel Enhancement Mode MOSFET****Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250μA	-20	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V,	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> = ±12V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.4	-0.8	-1.5	V
R <sub>DS(on)</sub> note2	Static Drain-Source on-Resistance	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2A	-	60	70	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2A	-	82	110	
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -10V, V <sub>GS</sub> =0V, f=1.0MHz	-	779	-	pF
C <sub>oss</sub>	Output Capacitance		-	121	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	56	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -10V, I <sub>D</sub> = -2A, V <sub>GS</sub> = -4.5V	-	4.1	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	0.8	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	1.1	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = -10V, I <sub>D</sub> = -3A, R <sub>G</sub> =1Ω, V <sub>GEN</sub> = -4.5V, R <sub>L</sub> =1.2Ω	-	10	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	9	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	27	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	11	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	-0.42	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-12	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = -3A	-	-	-1.2	V

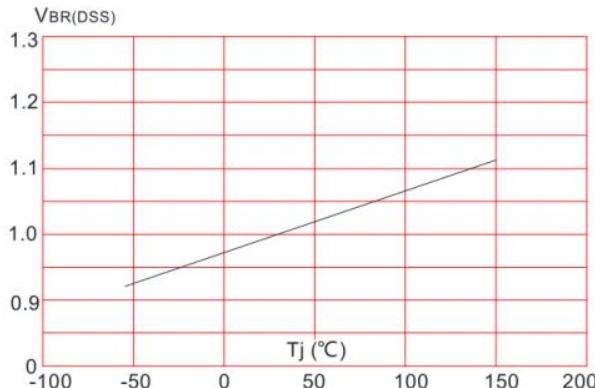
Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

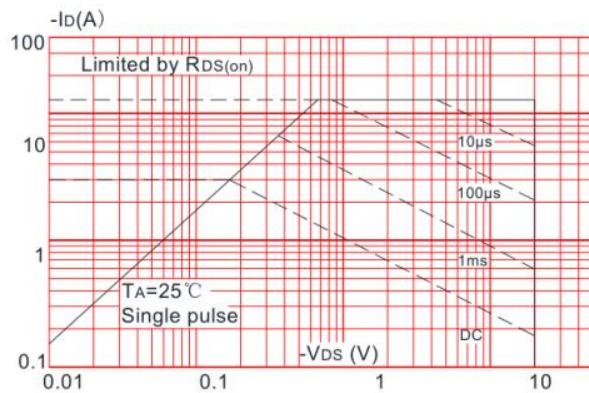
**-20V P-Channel Enhancement Mode MOSFET**
**Typical Performance Characteristics**
**Figure 1:** Output Characteristics**Figure 3:** On-resistance vs. Drain Current**Figure 5: Gate Charge Characteristics****Figure 2:** Typical Transfer Characteristics**Figure 4: Body Diode Characteristics****Figure 6: Capacitance Characteristics**

## -20V P-Channel Enhancement Mode MOSFET

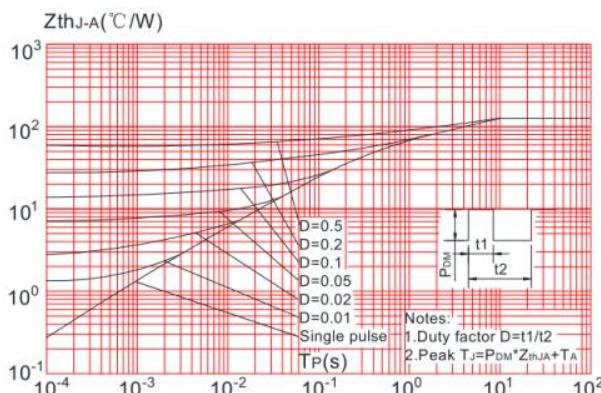
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



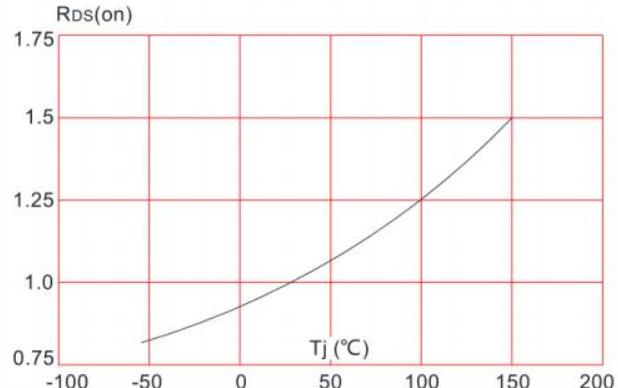
**Figure 9:** Maximum Safe Operating Area



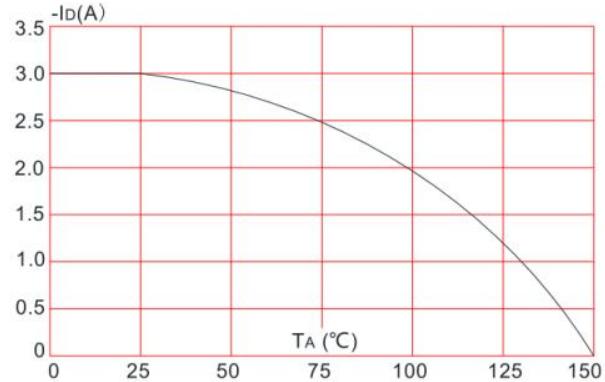
**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

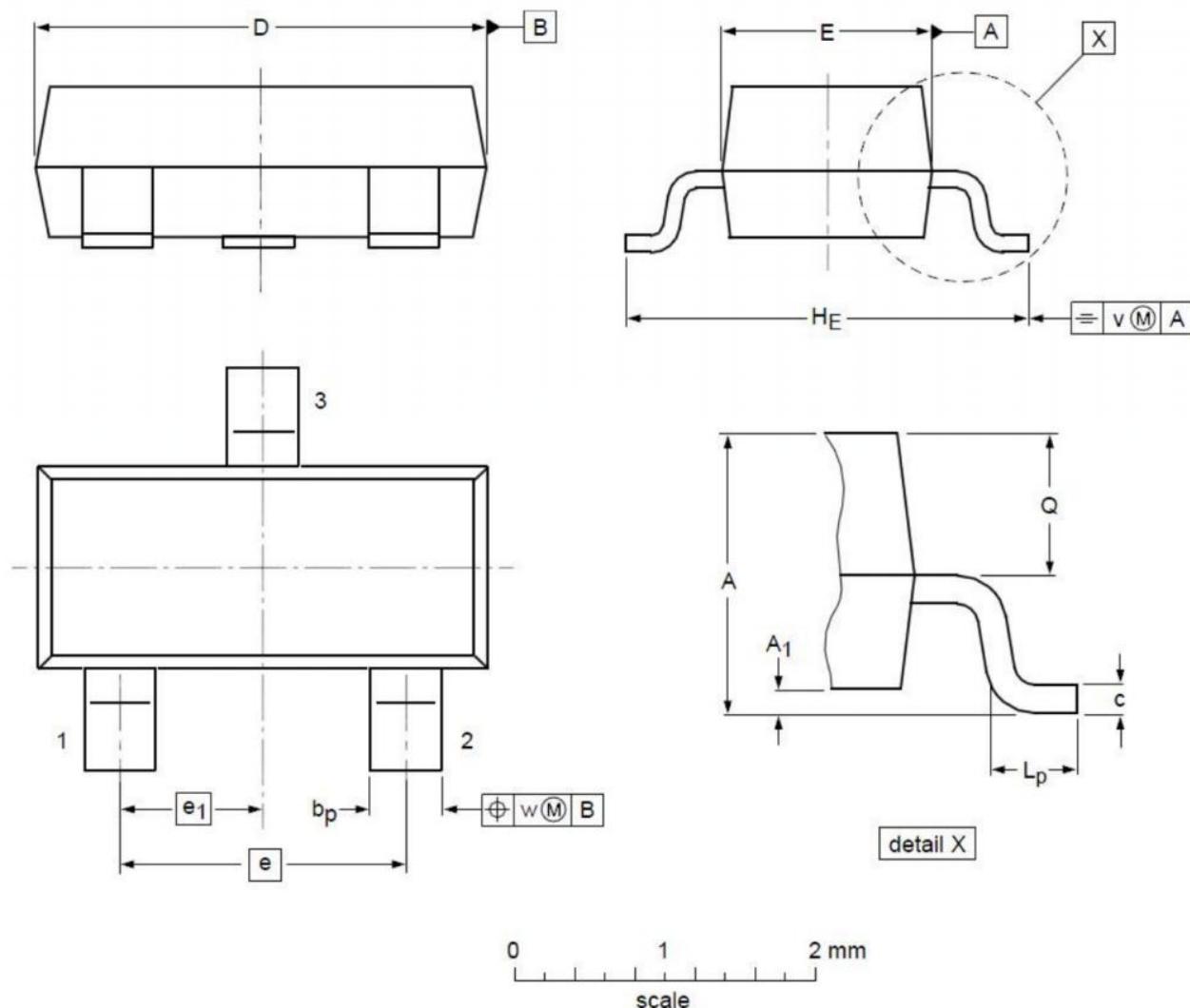


**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



**-20V P-Channel Enhancement Mode MOSFET**
**Package Mechanical Data-SOT-23**

**DIMENSIONS (unit : mm)**

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
<b>A</b>	0.90	1.01	1.15	<b>A<sub>1</sub></b>	0.01	0.05	0.10
<b>b<sub>p</sub></b>	0.30	0.42	0.50	<b>c</b>	0.08	0.13	0.15
<b>D</b>	2.80	2.92	3.00	<b>E</b>	1.20	1.33	1.40
<b>e</b>	--	1.90	--	<b>e<sub>1</sub></b>	--	0.95	--
<b>H<sub>E</sub></b>	2.25	2.40	2.55	<b>L<sub>p</sub></b>	0.30	0.42	0.50
<b>Q</b>	0.45	0.49	0.55	<b>v</b>	--	0.20	--
<b>w</b>	--	0.10	--				

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